Tyrone Camarero Specifications



Camerero: SSI200C3HE-22

Kev Feature

5G Core and Edge, Al Inference and Machine Learning, Network Function Virtualization, Cloud Computing

- Design with compliance to NEBS-Level 3
- Single Socket E (LGA-4677) 5th/4th Gen Intel® Xeon® Scalable processors
- 8 DIMM slots; Up to 2TB 3DS ECC DDR5-5600; R-DIMM/R-DIMM 3DS
- Up to 3 PCle 5.0 x16 FHHL, 1 PCle 5.0 X16 HHHL & 1 PCle 5.0 x8 FHHL expansion slots for Accelerator Add-On-Cards
- Up to 6 Configurable PCIe 5.0 slots (4 standard + 2 optional)
- Onboard 2x 10GbE ports
- 2x 2.5" NVMe drive bays
- Redundant 800W AC Power Supplies
- Ultra short depth, 2U Front I/O Edge Server
- 4x 4-PIN PWM 8cm Fan(s)





Processor/Cache

Single Socket E (LGA-4677), 5th Gen Intel® **Processor**

Xeon® / 4th Gen Intel® Xeon® Scalable processors, Up to 60C/120T; Up to 112.5MB

Note: Supports up to 350W TDP CPUs (Air

Cooled)*

*Air Cooled CPUs with TDP over 205W only supported under specific conditions. Contact a Tyrone representative for details.

Chipset

Intel® C741" Chipset

System Memory

Memory Capacity 8 DIMM slots, Max Memory (2DPC): Up to 2TB 5600MT/s ECC DDR5 RDIMM,

Memory Voltage -1.1V

Expansion Slot

2 PCle 5.0 x16 FHHL slot(s), 1 PCle 5.0 x16 **PCI-Express**

HHHL slot(s), 1 PCIe 5.0 x8 HHHL slot(s), Option A* 3 PCIe 5.0 x16 FHHL slot(s), 1 PCle 5.0 x16 HHHL slot(s), 1 PCle 5.0 x8

FHHL slot(s)

Option B*3 PCle 5.0 x16 FHHL slot(s), 2 PCIe 5.0 x8 HHHL slot(s), 1 PCIe 5.0 x8

HHHL slot(s)

(please contact Tyrone for the optional parts

list details)

Integrated Onboard

NVMe; RAID 0/1 support(Intel® VROC **NVMe**

RAID key required)

2 USB 2.0 port(s) (front), 2 USB 3.2 Gen1 **USB**

port(s) (front), 1 VGA port(s), Serial -1 port(s)

1 RJ45 1 GbE Dedicated BMC LAN port(s), 2 LAN

RJ45 10 GbE LAN port(s) (Intel® X550-AT2)

Add-on Options

Raid Card Optional **Optical Drive** None

Front Panel

LED HDD activity, LAN1 activity, LAN2 activity,

Power status, System information

Buttons Power On/Off UID button

Drive bays

HDD Bays 2 front hot-swap 2.5" NVMe drive

bay(s), 2 M.2 NVMe slot(s) (M-key

2280/22110)

Power Supply

Power Supply 2x 800W Redundant power supplies

Cooling System

4x 4-PIN PWM 8cm Fan(s)

Form Factor

Form Factor 2U Rackmount

Dimensions

Dimensions Height -3.5" (88.9 mm), Width -17.2"

(436.88 mm), Depth -11.8" (298.8 mm)

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